ATTORNEY DOCKET NUMBER: 2336-247

Sir:

Transmitted herewith for filing is the Utility patent application of:

INVENTOR (S):	Joo Ho LEE; Jea Shik SHIN				
For:	WAFER LEVEL PACKAGE FOR MICRO DEVICE AND MANUFACTURING METHOD THEREOF				

## Enclosed are:

- 20 pages of Specification, Claims and Abstract
- ≤ 5 sheets of formal drawings
- Declaration & Power of Attorney
- Claim of Priority under 35 U.S.C. § 119 and Certified copy of Korean Priority Document
- An assignment with PTO Form 1595
- Return Receipt Postcard

The filing fee is calculated as shown below:

	NO. FILED		NO. EXTRA	RATE	AMOUNT	
Total Claims	22	MINUS 20	2	x \$18 =	\$	36.00
Independent Claims	2	MINUS 3	0	x \$ 86 =	\$	0.00
If multiple dependent claims are presented, add \$ 290.00						
Basic Fee						
Applicant claims small entity status. See 37 CFR 1.27. The fees indicated above are reduced by ½.						
			Total of a	bove calculations	\$	806.00
TOTAL FEE						

A credit card authorization form to cover the filing fees is enclosed.

The Commissioner is hereby authorized to charge any additional fees associated with this communication, including patent application filing fees and processing fees under 37 C.F.R. § 1.16 and 1.17, or credit any overpayment to **Deposit Account Number 07-1337**.

Respectfully syomitted,

LOWE HAUPTMAN GILMAN & BERNER, LLP (22429)

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PATENT TRADEMARK OFFICE

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Date: March 3, 2

BJH:ETP

s. PTO 723

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